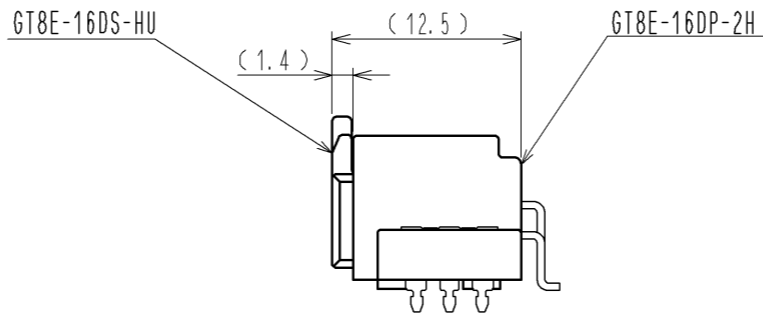
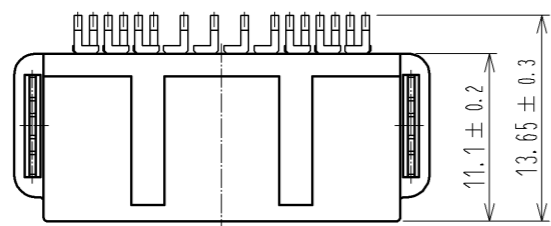
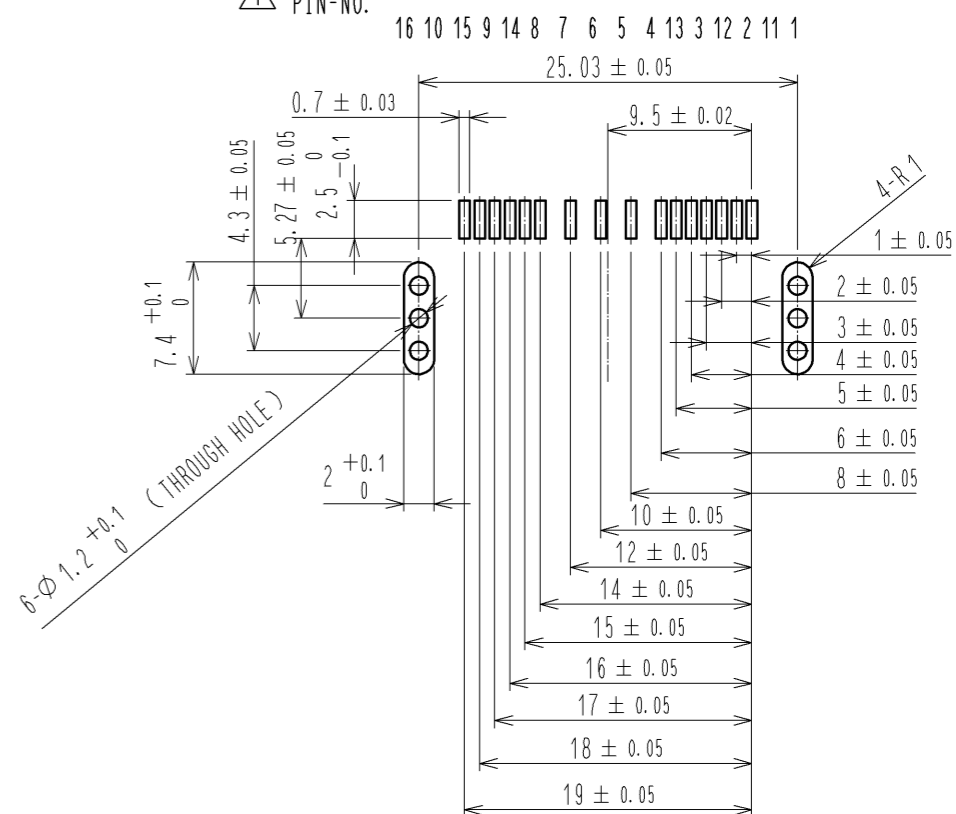


ELV, RoHS COMPLIANT

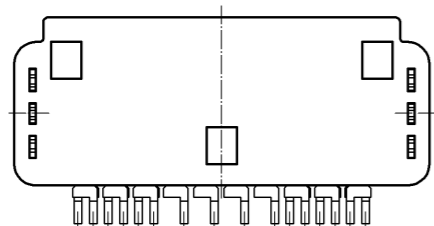
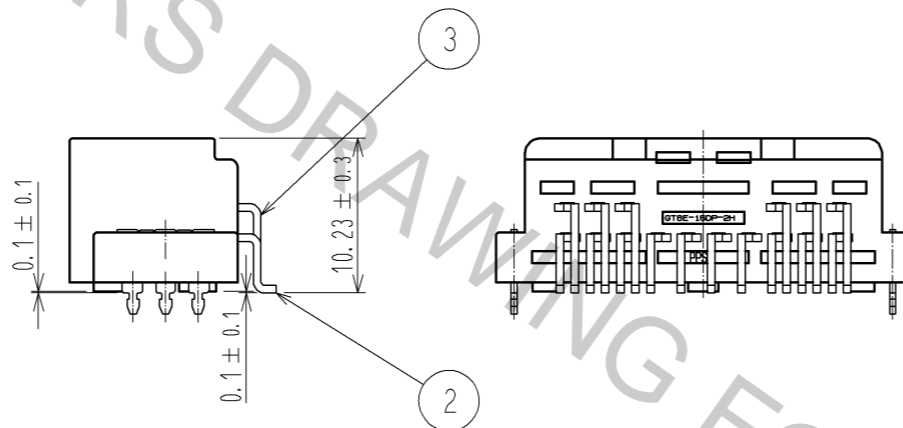
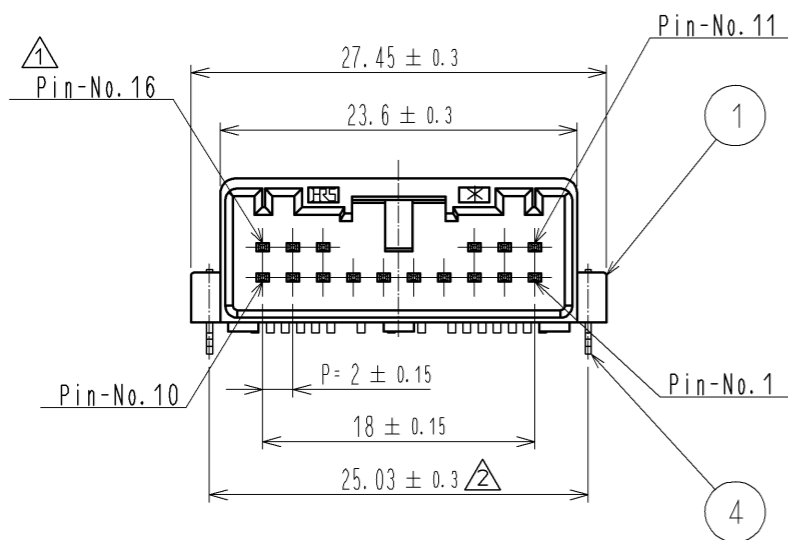


MATED CONNECTORS

\triangle PIN-NO.



RECOMMENDED PC BOARD PATTERN (CONNECTOR SIDE)



NOTE 1. RECOMMENDED REFLOW TEMPERATURE PROFILE (REFER RIGHT FIG.).

REFLOW HEATING: FAR-INFLARED, IN THE AIR OR NITROGEN

NUMBER OF REFLOW CYCLES: 2 CYCLES MAX

PEAK TEMPERATURE: 250°C

ABOVE 230°C: 20~40s

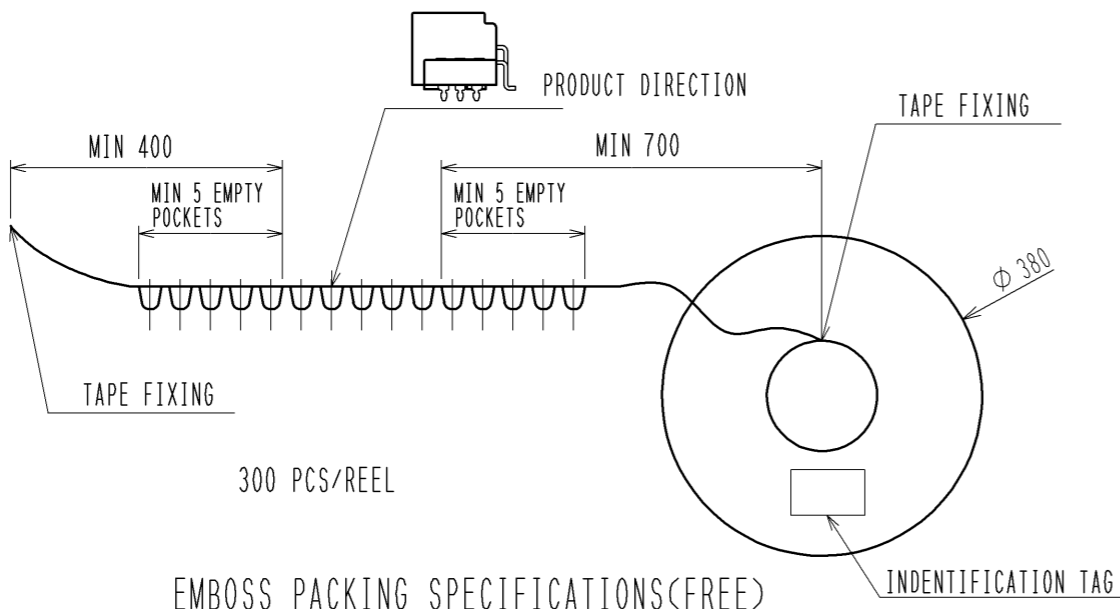
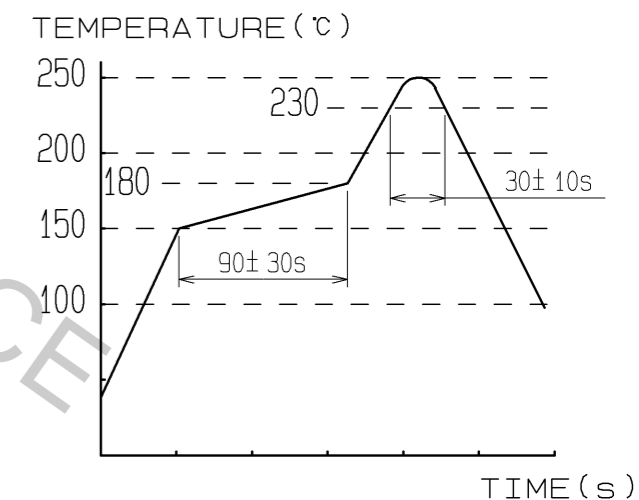
PREHEAT: 150~180°C (60~120s)

2. SOLDERING TEMPERATURE: 280~300°C (MAX 2s)

3. COPLANARITY OF LEADS SHALL BE 0.1mm MAX.

4. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.

5. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



300 PCS/REEL

EMBOSS PACKING SPECIFICATIONS(FREE)

2	BRASS	TIN PLATING	4	BRASS	TIN PLATING		
1	PPS	BLACK	3	BRASS	TIN PLATING		
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS		
UNITS mm	\odot \triangle	SCALE 2 : 1	COUNT \triangle 1	DESCRIPTION OF REVISIONS DIS-T-003270	DESIGNED RZ. KANO	CHECKED HS. OZAWA	DATE 13. 04. 17
APPROVED : AR. SHIRAI		12. 09. 14		DRAWING NO. EDC3-167885-00			
CHECKED : NH. NAKATA		12. 09. 14		PART NO. GT8E-16DP-2H			
DESIGNED : RZ. KANO		12. 09. 13		CODE NO. CL758-1009-5-00			
DRAWN : RZ. KANO		12. 09. 13					